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# **8-BIT SHIFT REGISTERS WITH 3-STATE OUTPUT REGISTERS**

Check for Samples: SN74HC595-EP

#### **FEATURES**

- 8-Bit Serial-In, Parallel-Out Shift
- Wide Operating Voltage Range of 2 V to 6 V
- High-Current 3-State Outputs Can Drive Up To 15 LSTTL Loads
- Low Power Consumption: 80-μA (Max) I<sub>CC</sub>
- t<sub>pd</sub> = 13 ns (Typ)
- ±6-mA Output Drive at 5 V
- Low Input Current: 1 μA (Max)
- Shift Register Has Direct Clear

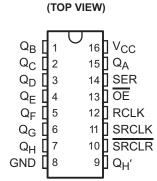
# SUPPORTS DEFENSE, AEROSPACE, AND MEDICAL APPLICATIONS

- Controlled Baseline
- One Assembly/Test Site
- One Fabrication Site
- Available in Military (–55°C/125°C)
   Temperature Range<sup>(1)</sup>
- Extended Product Life Cycle
- Extended Product-Change Notification
- Product Traceability
- (1) Additional temperature ranges available contact factory

# **DESCRIPTION**

The SN74HC595 contains an 8-bit serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. The storage register has parallel 3-state outputs. Separate clocks are provided for both the shift and storage register. The shift register has a direct overriding clear (SRCLR) input, serial (SER) input, and serial outputs for cascading. When the output-enable (OE) input is high, the outputs are in the high-impedance state.

Both the shift register clock (SRCLK) and storage register clock (RCLK) are positive-edge triggered. If both clocks are connected together, the shift register always is one clock pulse ahead of the storage register.



**PW PACKAGE** 



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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# ORDERING INFORMATION(1)

T <sub>A</sub>	PACK	AGE <sup>(2)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
-55°C to 125°C	TSSOP - PW	Reel of 2000	SN74HC595MPWREP	HC595EP

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

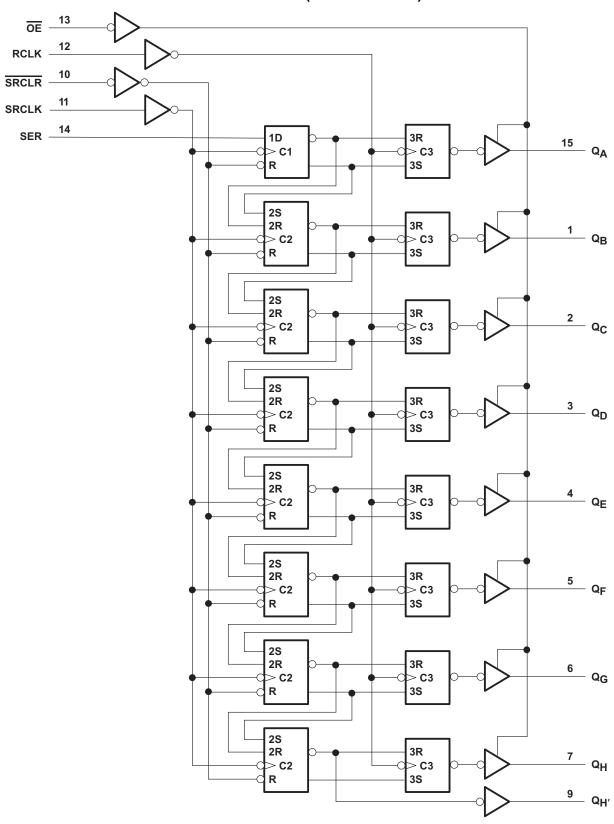
### **Table 1. FUNCTION TABLE**

		INPUTS			FUNCTION
SER	SRCLK	SRCLR	RCLK	OE	FUNCTION
X	X	Χ	Χ	Н	Outputs Q <sub>A</sub> -Q <sub>H</sub> are disabled.
X	X	Χ	Χ	L	Outputs Q <sub>A</sub> -Q <sub>H</sub> are enabled.
X	X	L	Χ	Χ	Shift register is cleared.
L	1	Н	X	Х	First stage of the shift register goes low. Other stages store the data of previous stage, respectively.
Н	<b>↑</b>	Н	Х	Х	First stage of the shift register goes high. Other stages store the data of previous stage, respectively.
Х	Х	Х	1	Х	Shift-register data is stored in the storage register.



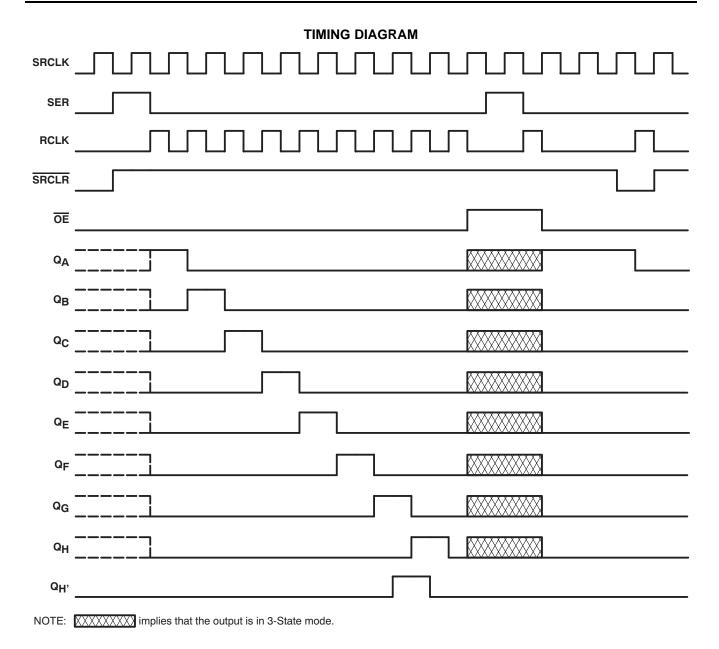
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# **LOGIC DIAGRAM (POSITIVE LOGIC)**



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# ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

$V_{CC}$	Supply voltage range		-0.5 V to 7 V			
I <sub>IK</sub>	Input clamp current <sup>(2)</sup>					
I <sub>OK</sub>	Output clamp current (2)	±20 mA				
Io	Continuous output current	±35 mA				
	Continuous current through VCC or GND		±70 mA			
$\theta_{JA}$	Package thermal impedance (3)		108°C/W			
T <sub>stg</sub>	Storage temperature range	−65°C to 150°C				

<sup>(1)</sup> Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

The package thermal impedance is calculated in accordance with JESD 51-7. (3)

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# **RECOMMENDED OPERATING CONDITIONS**(1)

			MIN	NOM	MAX	UNIT
V <sub>CC</sub>	Supply voltage		2	5	6	V
		V <sub>CC</sub> = 2 V	1.5			
$V_{IH}$	High-level input voltage	V <sub>CC</sub> = 4.5 V	3.15			V
		V <sub>CC</sub> = 6 V	4.2			
		V <sub>CC</sub> = 2 V			0.5	
$V_{IL}$	Low-level input voltage	$V_{CC} = 4.5 \text{ V}$			1.35	V
		V <sub>CC</sub> = 6 V			1.8	
VI	Input voltage		0		V <sub>CC</sub>	V
Vo	Output voltage		0		V <sub>CC</sub>	V
		V <sub>CC</sub> = 2 V			1000	
Δt/Δv	Input transition rise/fall time (2)	V <sub>CC</sub> = 4.5 V			500	ns
		V <sub>CC</sub> = 6 V			400	
T <sub>A</sub>	Operating free-air temperature		-55		125	°C

<sup>(1)</sup> All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. See the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

### **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED		TEST CONDITIONS			<sub>A</sub> = 25°C		$T_A = -55^{\circ}C$ to		
PARAMETER	I E	ST CONDITIONS	V <sub>CC</sub>	MIN	TYP	MAX	MIN	MAX	UNIT
			2 V	1.9	1.998		1.9		
		I <sub>OH</sub> = -20 μA	4.5 V	4.4	4.499		4.4		
			6 V	5.9	5.999		5.9		
$V_{OH}$	$V_I = V_{IH} \text{ or } V_{IL}$	$Q_{H'}$ , $I_{OH} = -4 \text{ mA}$	4.5 V	3.98	4.3		3.7		V
		$Q_A - Q_H$ , $I_{OH} = -6 \text{ mA}$	4.5 V	3.98	4.3		3.7		
		$Q_{H'}$ , $I_{OH} = -5.2 \text{ mA}$	6 V	5.48	5.8		5.2		
		$Q_A - Q_H$ , $I_{OH} = -7.8 \text{ mA}$	6 V	5.48	5.8		5.2		
			2 V		0.002	0.1		0.1	
		$I_{OL} = 20 \mu A$	4.5 V		0.001	0.1		0.1	
			6 V		0.001	0.1		0.1	
$V_{OL}$	$V_I = V_{IH}$ or $V_{IL}$	$Q_{H'}$ , $I_{OL} = 4 \text{ mA}$	4.5 V		0.17	0.26		0.4	V
		$Q_A - Q_H$ , $I_{OL} = 6 \text{ mA}$	4.5 V		0.17	0.26		0.4	
		$Q_{H'}$ , $I_{OL} = 5.2 \text{ mA}$	6 V		0.15	0.26		0.4	
		$Q_A - Q_H$ , $I_{OL} = 7.8 \text{ mA}$	O V		0.15	0.26		0.4	
$I_{l}$	$V_I = V_{CC}$ or 0	6 V		±0.1	±100		±1000	nA	
I <sub>OZ</sub>	$V_O = V_{CC}$ or 0, 0	Q <sub>A</sub> -Q <sub>H</sub>	6 V		±0.01	±0.5		±10	μΑ
I <sub>CC</sub>	$V_I = V_{CC}$ or 0, $I_C$	) = 0	6 V			8		160	μΑ
C <sub>i</sub>			2 V to 6 V		3	10		10	pF

<sup>(2)</sup> If this device is used in the threshold region (from V<sub>IL</sub>max = 0.5 V to V<sub>IH</sub>min = 1.5 V), there is a potential to go into the wrong state from induced grounding, causing double clocking. Operating with the inputs at t<sub>t</sub> = 1000 ns and V<sub>CC</sub> = 2 V does not damage the device; however, functionally, the CLK inputs are not ensured while in the shift, count, or toggle operating modes.

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## **TIMING REQUIREMENTS**

over operating free-air temperature range (unless otherwise noted)

			V	T <sub>A</sub> = 25	5°C	T <sub>A</sub> = -55°C t	o 125°C	LINUT	
			V <sub>cc</sub>	MIN	MAX	MIN	MAX	UNIT	
			2 V		6		4.2		
f <sub>clock</sub>	Clock frequency		4.5 V		31		21	MHz	
			6 V		36		25	•	
			2 V	80		120			
		SRCLK or RCLK high or low	4.5 V	16		24		•	
	Dules dureties		6 V	14		20			
t <sub>w</sub>	Pulse duration		2 V	80		120		ns	
		SRCLR low	4.5 V	16		24		•	
			6 V	14		20		•	
			2 V	100		150			
		SER before SRCLK↑	4.5 V	20		30		•	
			6 V	17		25		•	
			2 V	75		113			
		SRCLK↑ before RCLK↑ <sup>(1)</sup>	4.5 V	15		23			
	Catua tima		6 V	13		19			
t <sub>su</sub>	Setup time		2 V	50		75		ns	
		SRCLR low before RCLK↑	4.5 V	10		15			
			6 V	9		13			
			2 V	50		75			
		SRCLR high (inactive) before SRCLK↑	4.5 V	10		15			
			6 V	9		13		ĺ	
			2 V	0		0			
t <sub>h</sub>	h Hold time, SER after SRCLK↑		4.5 V	0		0		ns	
			6 V	0		0			

This setup time allows the storage register to receive stable data from the shift register. The clocks can be tied together, in which case the shift register is one clock pulse ahead of the storage register.



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## **SWITCHING CHARACTERISTICS**

over recommended operating free-air temperature range,  $C_L$  = 50 pF (unless otherwise noted)

DADAMETED	FROM	то	V	$T_A$	= 25°C		$T_A = -55^{\circ}C$ to	125°C	LINUT	
PARAMETER	(INPUT)	(OUTPUT)	V <sub>cc</sub>	MIN	TYP	MAX	MIN	MAX	UNIT	
			2 V	6	26		4.2			
f <sub>max</sub>			4.5 V	31	38		21		MHz	
			6 V	36	42		25			
			2 V		50	160		240		
	SRCLK	Q <sub>H</sub> ′	4.5 V		17	32		48		
			6 V		14	27		41		
t <sub>pd</sub>			2 V		50	150		225	ns	
	RCLK	Q <sub>A</sub> -Q <sub>H</sub>	4.5 V		17	30		45		
			6 V		14	26		38		
			2 V		51	175		261		
t <sub>PHL</sub>	SRCLR	$Q_{H'}$	4.5 V		18	35		52	ns	
			6 V		15	30		44		
			2 V		40	150		255	ns	
t <sub>en</sub>	ŌĒ	Q <sub>A</sub> -Q <sub>H</sub>	4.5 V		15	30		45		
			6 V		13	26		38		
			2 V		42	200		300		
t <sub>dis</sub>	ŌĒ	Q <sub>A</sub> -Q <sub>H</sub>	4.5 V		23	40		60	ns	
			6 V		20	34		51		
			2 V		28	60		90		
		Q <sub>A</sub> -Q <sub>H</sub>	4.5 V		8	12		18		
			6 V		6	10		15		
t <sub>t</sub>			2 V		28	75		110	ns	
		$Q_{H'}$	4.5 V		8	15		22		
			6 V		6	13		19		

## **SWITCHING CHARACTERISTICS**

over recommended operating free-air temperature range,  $C_1 = 150 \text{ pF}$  (unless otherwise noted)

DADAMETED	FROM	то	v	T <sub>A</sub> :	= 25°C		$T_A = -55$ °C to 125°C	UNIT
PARAMETER	(INPUT)	(OUTPUT)	V <sub>cc</sub>	MIN	TYP	MAX	MIN MAX	UNII
			2 V		60	200	300	
t <sub>pd</sub>	RCLK	$Q_A - Q_H$	4.5 V		22	40	60	ns
			6 V		19	34	51	
			2 V		70	200	298	
t <sub>en</sub>	ŌĒ	$Q_A - Q_H$	4.5 V		23	40	60	ns
			6 V		19	34	51	
			2 V		45	210	315	
t <sub>t</sub>		Q <sub>A</sub> -Q <sub>H</sub>	4.5 V		17	42	63	ns
			6 V		13	36	53	

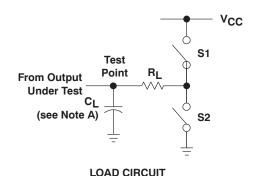
## **OPERATING CHARACTERISTICS**

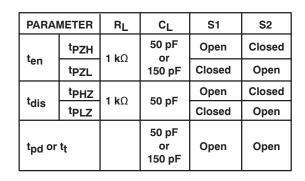
 $T_{\Delta} = 25^{\circ}C$ 

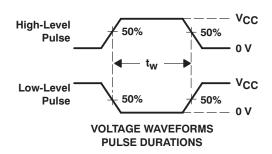
1A - 20	, 0			
	PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	No load	400	pF

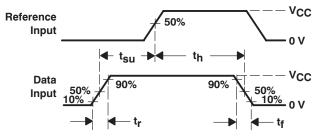


#### PARAMETER MEASUREMENT INFORMATION

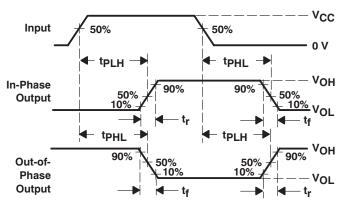


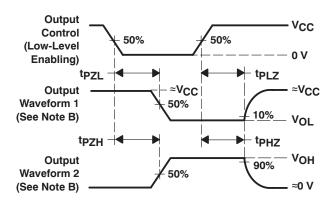






VOLTAGE WAVEFORMS
SETUP AND HOLD AND INPUT RISE AND FALL TIMES





VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT TRANSITION TIMES

VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

NOTES: A. C<sub>L</sub> includes probe and test-fixture capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \ \Omega$ ,  $t_f = 6 \ ns$ ,  $t_f = 6 \ ns$ .
- D. For clock inputs,  $f_{\mbox{max}}$  is measured when the input duty cycle is 50%.
- E. The outputs are measured one at a time, with one input transition per measurement.
- F. tpLz and tpHz are the same as tdis.
- G. tpzL and tpzH are the same as ten.
- H. tplH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



# PACKAGE OPTION ADDENDUM

6-Feb-2020

#### **PACKAGING INFORMATION**

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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
SN74HC595MPWREP	ACTIVE	TSSOP	PW	16		Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HC595EP	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN74HC595-EP:



# **PACKAGE OPTION ADDENDUM**

6-Feb-2020

Catalog: SN74HC595

Military: SN54HC595

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

# PACKAGE MATERIALS INFORMATION

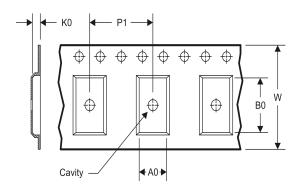
www.ti.com 14-Jul-2012

# TAPE AND REEL INFORMATION

### **REEL DIMENSIONS**



# TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

## TAPE AND REEL INFORMATION

### \*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74HC595MPWREP	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

www.ti.com 14-Jul-2012



#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74HC595MPWREP	TSSOP	PW	16	2000	367.0	367.0	35.0



SMALL OUTLINE PACKAGE



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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